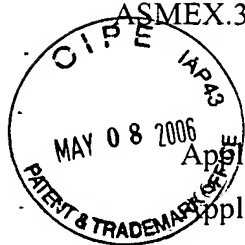


ASMEX.376A

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Applicant : Todd *et al.*
Appl. No. : 10/623,482
Filed : July 18, 2003
For : METHOD TO FORM ULTRA
HIGH QUALITY SILICON-
CONTAINING COMPOUND
LAYERS
Examiner : Ron Everett Pompey
Group Art Unit : 2812

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA, 22313, on

May 3, 2006

(Date)

Zi Y. Wong, Reg. No. 58,410

**COMMENTS ACCOMPANYING REQUEST FOR CONTINUED EXAMINATION
AND REQUEST FOR WITHDRAWAL OF FINALITY AND REFUND OF FEES**

Mail Stop RCE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the final Office Action mailed November 3, 2005 and the Advisory Actions mailed February 10, 2006 and April 6, 2006, Applicants respectfully request reconsideration of the rejections and full consideration of the remarks contained herein.

A Listing of the Claims begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.